# Hall D Wire Characterization Samples S4-1 & S4-2

- 1. Sample preparation: ultrasonic cleaning in DI water for 45 minutes.
- 2. **Sample installation:** for SEM inspection wires were installed on a sample holder (diameter=36 mm) on 2 stripes of conductive carbon tape, 2 fragment of each sample per stripe (nomenclature: S4-1a, S4-1b and S4-2a, S4-2b).

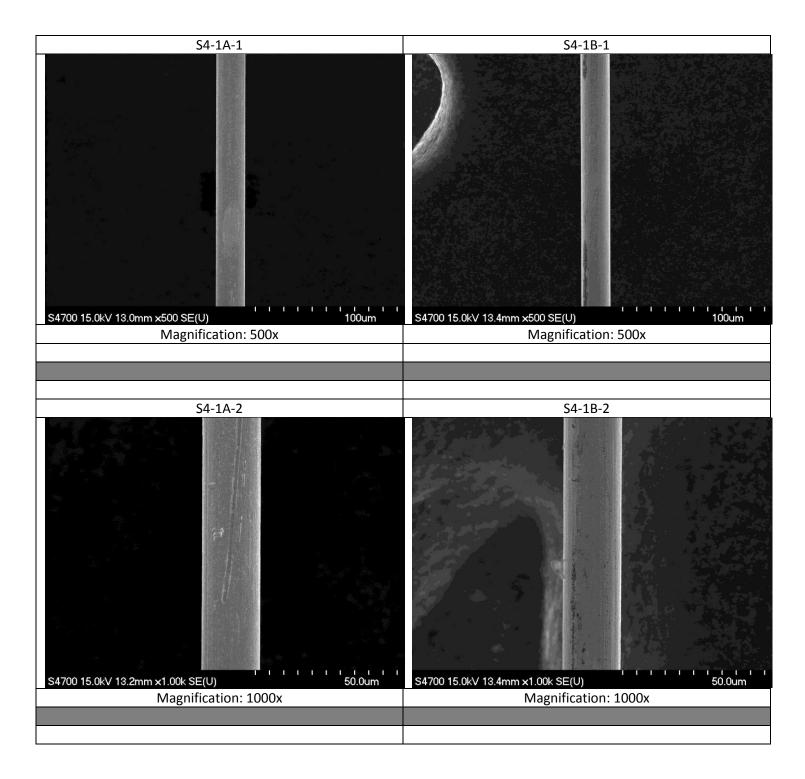


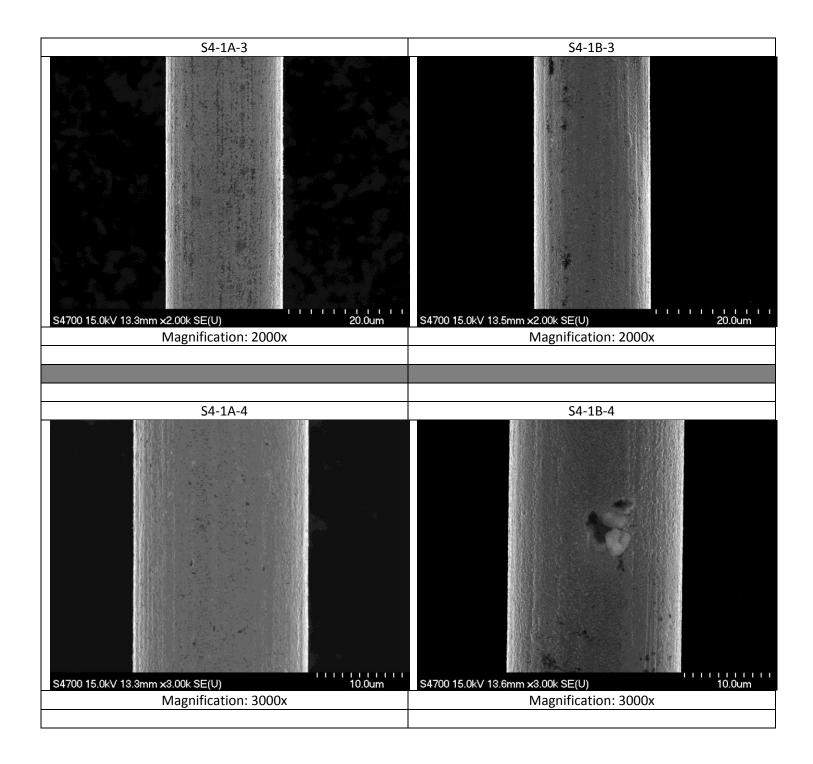
Pic1. Typical sample installation.

## 3. Wire inspection:

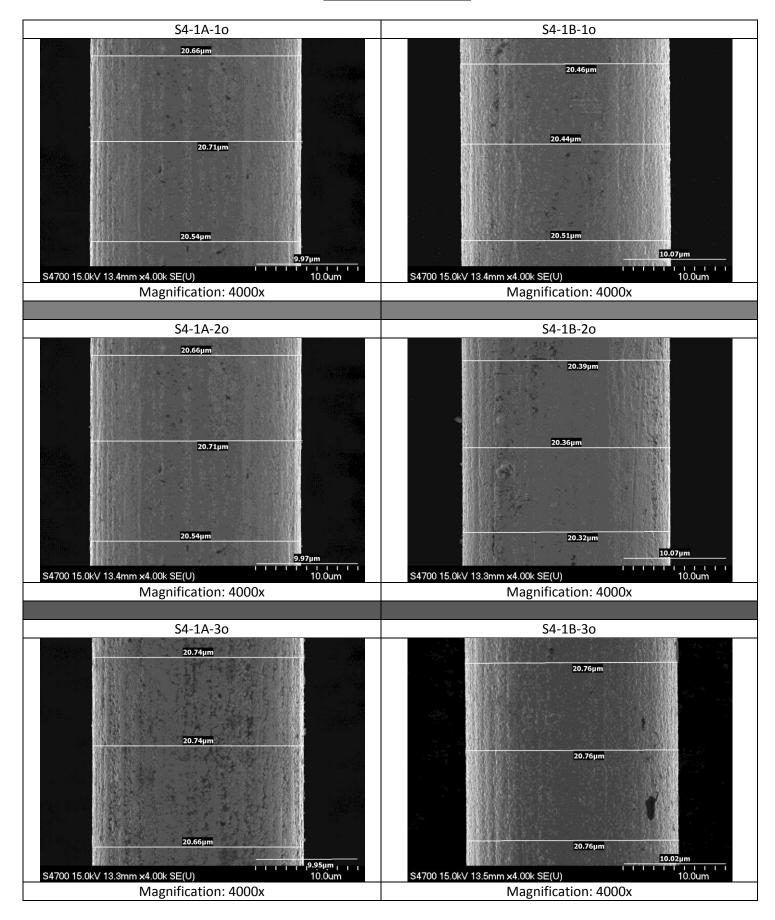
- a) Each wire fragment was examined along its length (beginning at approximately 5mm from the sample holder edge and ending ~5mm before the opposite edge) at magnification of ~1Kx, at fast scan rate.
- b) Images at designated magnifications were taken randomly along the sample length;
- c) Images for the ovality measurements were taken at 4000x magnification in three points of each wire fragment: in the middle (approximately) and close to both ends;
- d) Measurements of wire diameter, as visible on the images, were done using the Quartz PCI Image Management System, 3 measurements per image;
- e) Additional images at various magnifications were taken at the points of interest (variations in sample topography, contaminated areas, etc.)
- f) EDS analysis was performed on the most typical points of interest.

# Sample S4-1 A, B I. Images at designated magnifications

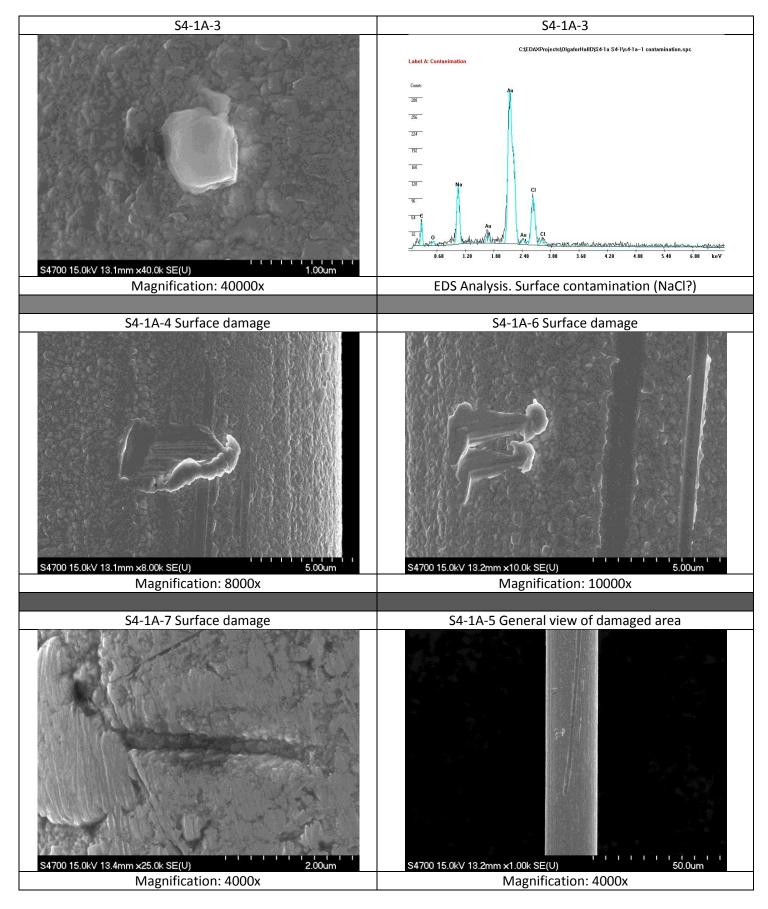




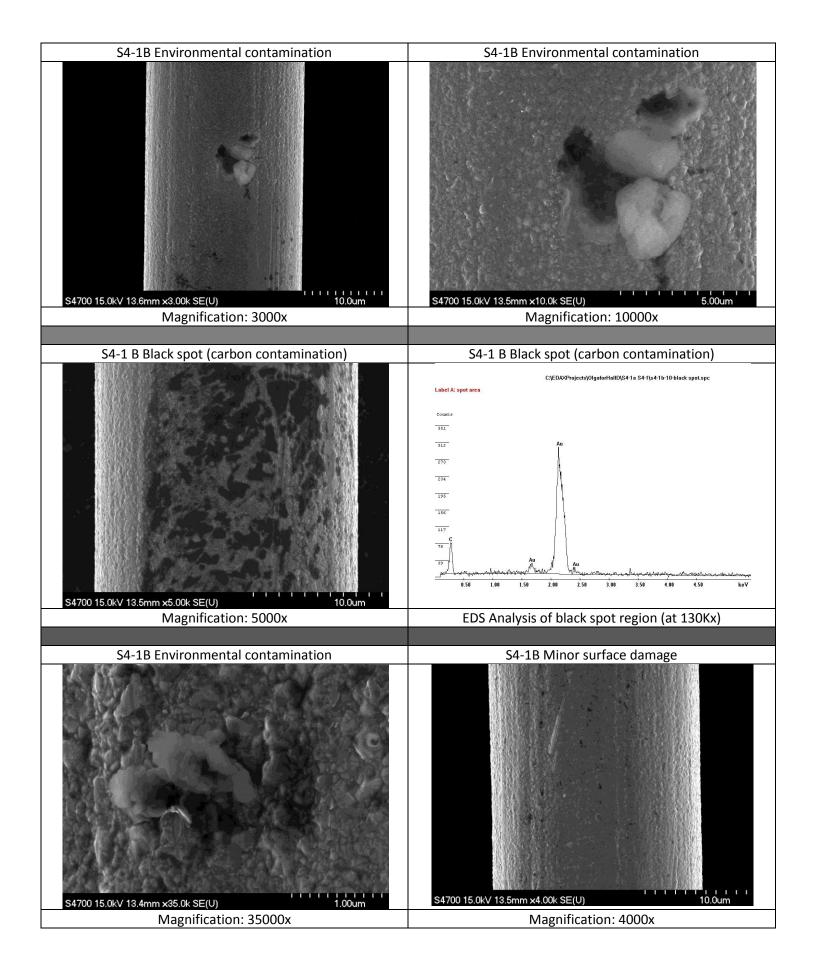
#### II. Ovality Measurements



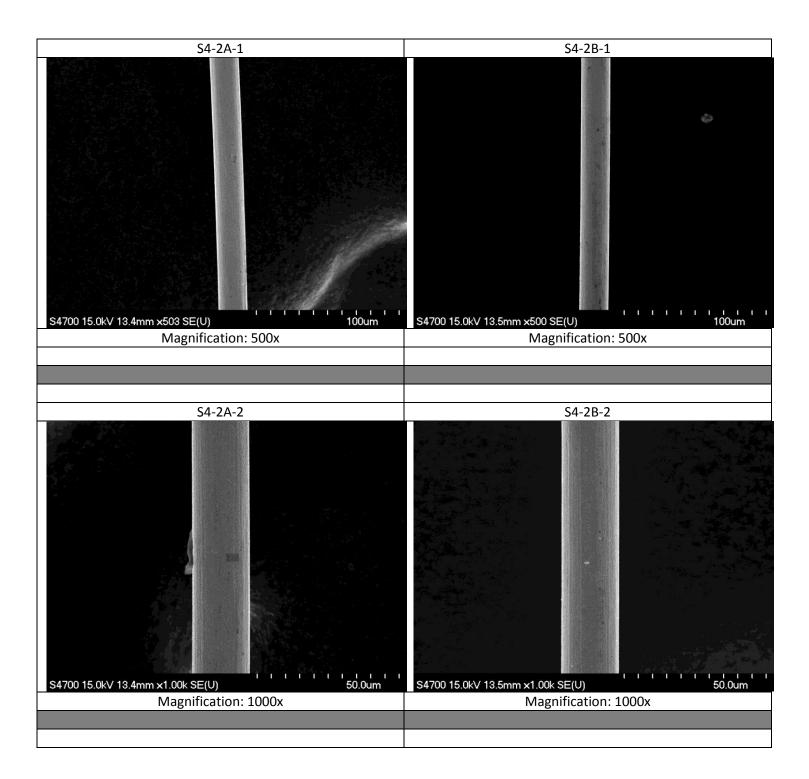
## III. Points of Interest

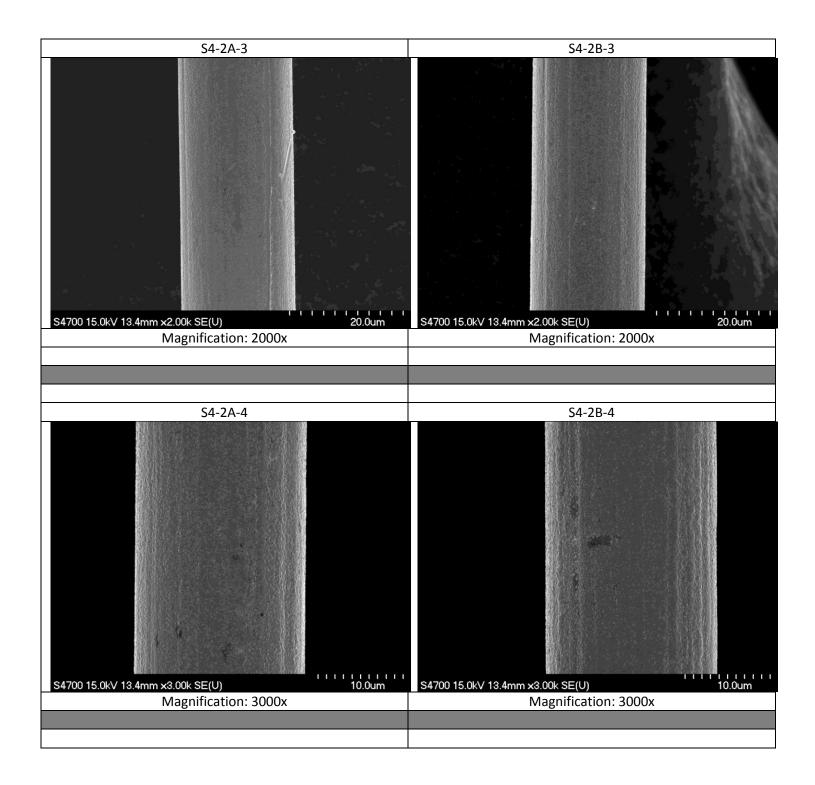


Note. No W was indicated by EDS scan in the damaged area (detection limit ~ 1%).

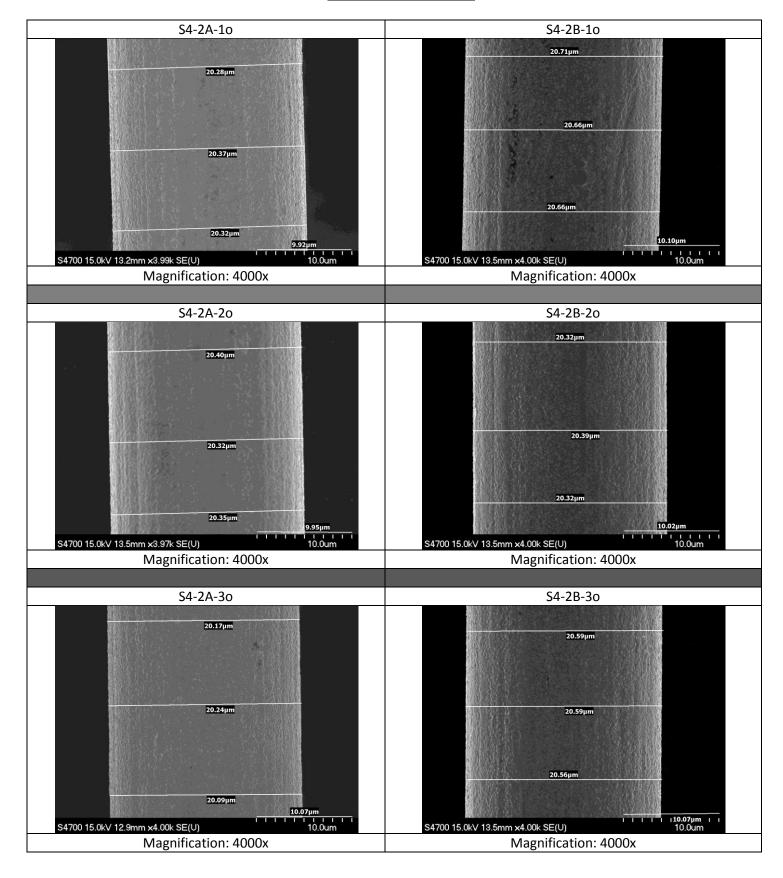


# Sample S4-2 A, B Images at designated magnifications





#### II. Ovality Measurements



### III. Points of Interest

